

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		VDSS	60	V
Gate-Source Voltage		V _{GSS}	±20	V
Continuous Drain Current, V _{GS} = 10V (Note 6)	Tc = +25°C Tc = +100°C	Ы	205 145	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	820	А
Continuous Body Diode Forward Current (Note 6)	Tc = +25°C	ls	205	А
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)	I _{SM}	820	А	
Avalanche Current, L = 3mH	las	14	А	
Avalanche Energy, L = 3mH		EAS	294	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	3	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{0JA}	50	°C/W
Total Power Dissipation (Note 6) T _C = +2		PD	167	W
Thermal Resistance, Junction to Case (Note 6)	Rejc	0.9	°C/W	
Operating and Storage Temperature Range	TJ, TSTG	-55 to +175	°C	

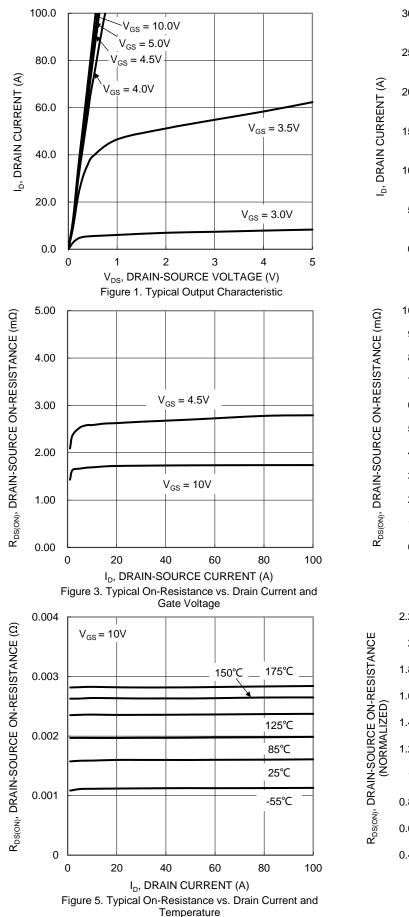
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

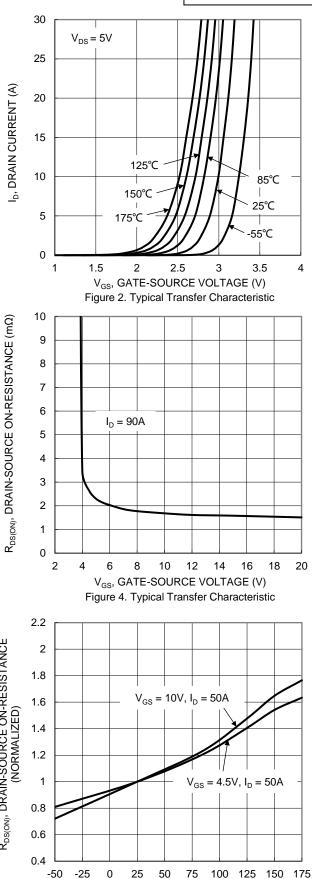
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)				1		
Drain-Source Breakdown Voltage	BV _{DSS}	60	—		V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	V _{DS} = 48V, V _{GS} = 0V
Gate-Source Leakage	IGSS		_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						÷
Gate Threshold Voltage	V _{GS(TH)}	1	_	3	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
		_	1.7	2		Vgs = 10V, ID = 30A
Static Drain-Source On-Resistance	RDS(ON)	_	2	3	mΩ	Vgs = 6V, ID = 30A
		_	2.3	3.3		$V_{GS} = 4.5V, I_D = 30A$
Diode Forward Voltage	Vsd		_	1.2	V	Vgs = 0V, Is = 50A
DYNAMIC CHARACTERISTICS (Note 8)						÷
Input Capacitance	Ciss	_	6555	_	pF	
Output Capacitance	Coss	_	2264	_		$V_{DS} = 30V, V_{GS} = 0V,$ f = 1MHz
Reverse Transfer Capacitance	Crss	_	187	_		
Gate Resistance	Rg		0.7		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (V _{GS} = 10V)	Qg	_	130.8	_		
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	63.6	_	nC Vps = 30V. lp = 5	
Gate-Source Charge	Qgs	_	20.8	_	nc	$V_{DS} = 30V, I_D = 50A$
Gate-Drain Charge	Q _{gd}		29.4			
Turn-On Delay Time	tD(ON)	_	11.2			
Turn-On Rise Time	t _R	_	10.8			$V_{DD} = 20V, V_{GS} = 10V,$
Turn-Off Delay Time	tD(OFF)	_	44	_	ns	$I_{D} = 50A, R_{g} = 2.5\Omega$
Turn-Off Fall Time	tF	_	19.5]	
Reverse Recovery Time	trr	_	61.8	_	ns	
Reverse Recovery Charge	Q _{RR}	_	123		nC	I _F = 50A, di/dt = 100A/μs

 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
Thermal resistance from junction to soldering point (on the exposed drain pad).
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing. Notes:









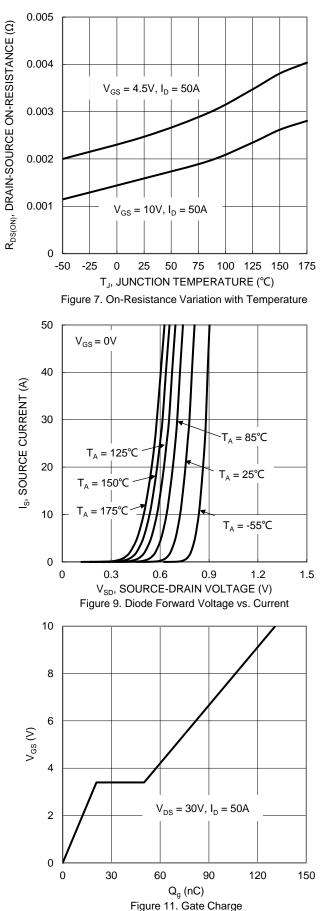
TJ, JUNCTION TEMPERATURE (°C)

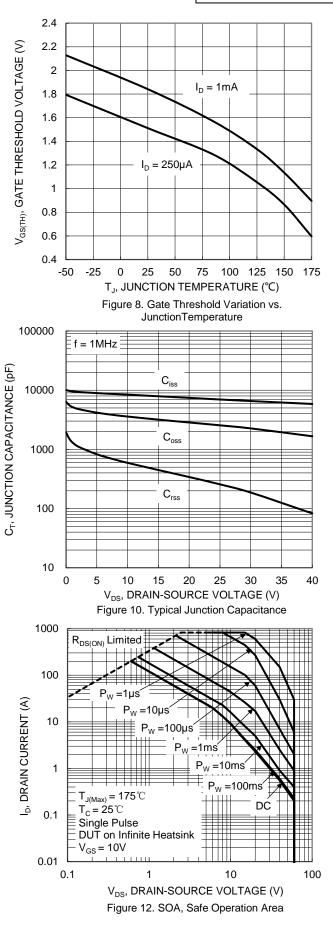
Figure 6. On-Resistance Variation with Temperature

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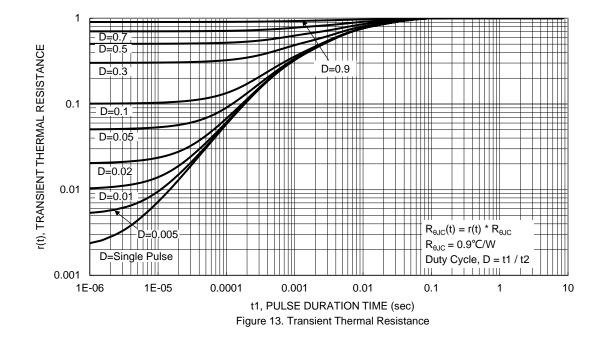






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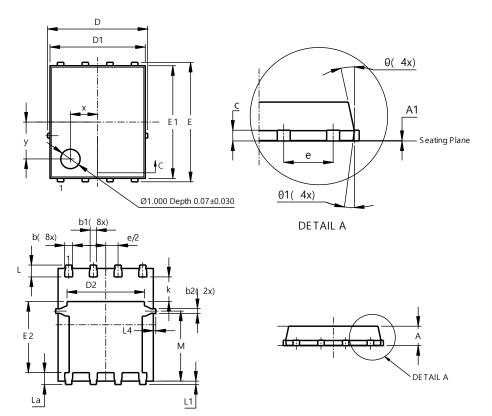






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



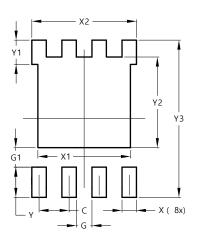
PowerDI5060-8 (Type K)

	PowerDI5060-8 (Type K)					
Dim	Min Max		Тур			
Α	0.90	1.10	1.00			
A1	0	0.05	0.02			
b	0.33	0.51	0.41			
b1	0.300	0.366	0.333			
b2	0.20	0.35	0.25			
С	0.23	0.33	0.277			
D	5.15 BSC					
D1	4.85	4.95	4.90			
D2	-	-	3.98			
E	6.15 BSC					
E1	5.75	5.85	5.80			
E2	3.56	3.725	3.66			
е	1.27BSC					
k	-					
L	0.51	0.71	0.61			
La	0.51	0.675	0.61			
L1	0.05	0.20	0.175			
L4	-	-	0.125			
М	3.50	3.71	3.605			
х	-	-	1.400			
У	-	-	1.900			
θ	10°	12°	11°			
θ1	6°	8°	7°			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (Type K)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	3.910		
X2	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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